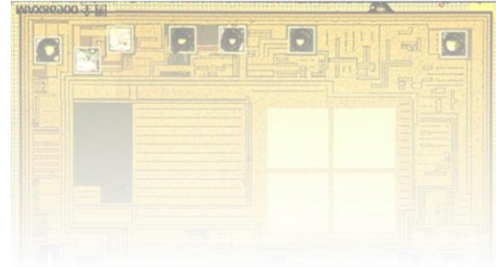
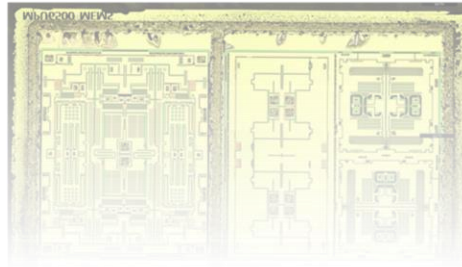
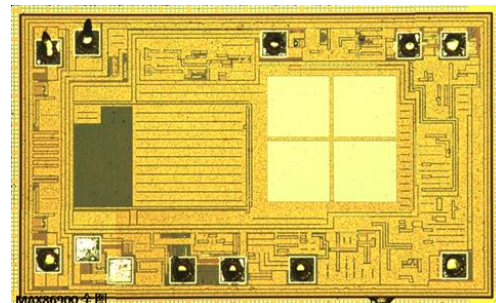
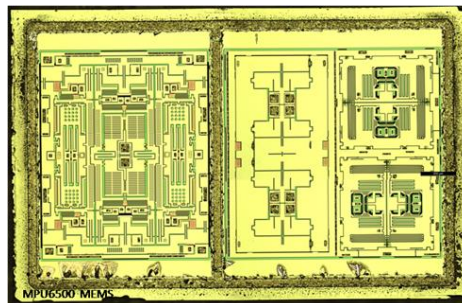


# Samsung Galaxy S5 SM-G9009D



## Teardown Analysis Report

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# Samsung Galaxy S5 Product Analysis Report

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